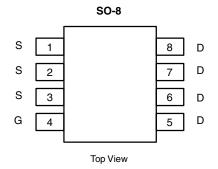


HALOGEN FREE

## SI4455DY-T1-E3-VB Datasheet P-Channel 150-V (D-S) MOSFET

| PRODUCT SUMMARY     |                                    |                    |                          |  |  |  |
|---------------------|------------------------------------|--------------------|--------------------------|--|--|--|
| V <sub>DS</sub> (V) | $R_{DS(on)}(\Omega)$               | I <sub>D</sub> (A) | A) Q <sub>g</sub> (Typ.) |  |  |  |
| - 150               | 0.160 at V <sub>GS</sub> = - 10 V  | - 2.8 <sup>c</sup> | 23.2 nC                  |  |  |  |
| - 150               | 0.200 at V <sub>GS</sub> = - 4.5 V | - 2.3 <sup>c</sup> | 23.2 110                 |  |  |  |

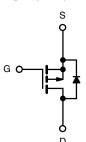


#### **FEATURES**

- Trench Power MOSFET
- 100% R<sub>g</sub> and UIS Tested

#### **APPLICATIONS**

- Active Clamp in Intermediate DC/ DC Power Supplies
- H-Bridge High Side Switch for Lighting Application



P-Channel MOSFET

| <b>ABSOLUTE MAXIMUM RATINGS (</b>                  | $T_A = 25  ^{\circ}C$ , unless oth | nerwise noted    | )                     |    |  |
|--|------------------------------------|------------------|-----------------------|----|--|
| Parameter  | Symbol                             | Limit            | Unit                  |    |  |
| Drain-Source Voltage                               | V <sub>DS</sub>                    | - 150            | V                     |    |  |
| Gate-Source Voltage                                | V <sub>GS</sub>                    | ± 20             | V                     |    |  |
|  | T <sub>C</sub> = 25 °C             |                  | - 2.8                 |    |  |
| Continuous Drain Current (T = 150 °C)              | T <sub>C</sub> = 70 °C             | 1 , [            | - 2.3                 |    |  |
| Continuous Drain Current (T <sub>J</sub> = 150 °C) | T <sub>A</sub> = 25 °C             | 'D               | - 2 <sup>a, b</sup>   |    |  |
|  | T <sub>A</sub> = 70 °C             |                  | - 1.6 <sup>a, b</sup> |    |  |
| Pulsed Drain Current                               |                                    | I <sub>DM</sub>  | - 15                  | Α  |  |
|  | T <sub>C</sub> = 25 °C             | ,                | - 4.9                 |    |  |
| Continuous Source-Drain Diode Current              | T <sub>A</sub> = 25 °C             | l <sub>s</sub> – | - 2.5 <sup>a, b</sup> |    |  |
| Avalanche Current                                  | 1 0.1 ml l                         | I <sub>AS</sub>  | - 15                  |    |  |
| Single-Pulse Avalanche Energy                      | L = 0.1 mH                         | E <sub>AS</sub>  | 11.25                 | mJ |  |
|  | T <sub>C</sub> = 25 °C             |                  | 5.9                   |    |  |
| Manianum Danian Disabahan                          | T <sub>C</sub> = 70 °C             | 1 , [            | 3.8                   | W  |  |
| Maximum Power Dissipation                          | T <sub>A</sub> = 25 °C             | P <sub>D</sub>   | 3.1 <sup>a, b</sup>   | VV |  |
|  | T <sub>A</sub> = 70 °C             | 1                | 2 <sup>a, b</sup>     |    |  |
| Operating Junction and Storage Temperature Rang    | T <sub>J</sub> , T <sub>stg</sub>  | - 55 to 150      | °C                    |    |  |

#### Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Based on  $T_C$  = 25 °C.

| THERMAL RESISTANCE RATINGS                  |              |                   |         |         |      |  |
|---|--------------|-------------------|---------|---------|------|--|
| Parameter                                   |              | Symbol            | Typical | Maximum | Unit |  |
| Maximum Junction-to-Ambient <sup>a, b</sup> | t ≤ 10 s     | R <sub>thJA</sub> | 33      | 40      | °C/W |  |
| Maximum Junction-to-Foot (Drain)            | Steady State | R <sub>thJF</sub> | 17      | 21      | C/VV |  |

#### Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. Maximum under steady state conditions is 80  $^{\circ}\text{C/W}.$

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| Parameter                                     | Symbol   | Test Conditions   | Min.  | Тур.  | Max.  | Unit  |
|---|--|---|-------|-------|-------|-------|
| Static  |  |   |       |       |       |       |
| Drain-Source Breakdown Voltage                | $V_{DS}$   | $V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$                                      | - 150 |       |       | V     |
| V <sub>DS</sub> Temperature Coefficient       | $\Delta V_{DS}/T_{J}$  | I <sub>D</sub> = - 250 μA   |       | - 165 |       | \//0C |
| V <sub>GS(th)</sub> Temperature Coefficient   | $\Delta V_{GS(th)}/T_J$  | η   |       | - 6.6 |       | mV/°C |
| Gate-Source Threshold Voltage                 | V <sub>GS(th)</sub>  | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$   | - 2   |       | - 4   | V     |
| Gate-Source Leakage                           | I <sub>GSS</sub>   | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$                                   |       |       | ± 100 | nA    |
| Zara Cata Valtaga Drain Current               | I <sub>DSS</sub>   | V <sub>DS</sub> = - 150 V, V <sub>GS</sub> = 0 V                                    |       |       | - 1   |       |
| Zero Gate Voltage Drain Current               |  | V <sub>DS</sub> = - 150 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C            |       |       | - 10  | μΑ    |
| On-State Drain Current <sup>a</sup>           | I <sub>D(on)</sub>   | $V_{DS} \ge -5 \text{ V}, V_{GS} = -10 \text{ V}$                                   | - 8   |       |       | Α     |
|   | В  | V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 2 A                                    |       | 0.160 |       |       |
| Drain-Source On-State Resistance <sup>a</sup> | $R_{DS(on)}$   | V <sub>GS</sub> = - 4.5V, I <sub>D</sub> = - 1.5 A                                  |       | 0.200 |       | Ω     |
| Forward Transconductance <sup>a</sup>         | 9 <sub>fs</sub>  | V <sub>DS</sub> = - 15 V, I <sub>D</sub> = 2 A                                      |       | 12    |       | S     |
| Dynamic <sup>b</sup>                          |  |   | ·     |       | I.    | ı     |
| Input Capacitance                             | C <sub>iss</sub>   |   |       | 1190  |       |       |
| Output Capacitance                            | C <sub>oss</sub>   | $V_{DS} = -50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$                   |       | 61    |       | pF    |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>   |   |       | 42    |       |       |
| ·   | Q <sub>g</sub> V <sub>DS</sub> = -75 V, V <sub>GS</sub> = -10 V, I <sub>D</sub> = -2 A | $V_{DS} = -75 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -2 \text{ A}$              |       | 27.5  | 42    |       |
| Total Gate Charge                             |  |   | 23.2  | 35    | 1     |       |
| Gate-Source Charge                            | Q <sub>gs</sub>  | $V_{DS} = -75 \text{ V}, V_{GS} = -6 \text{ V}, I_{D} = -2 \text{ A}$               |       | 5.4   |       | nC    |
| Gate-Drain Charge                             | Q <sub>gd</sub>  |   |       | 8.4   |       |       |
| Gate Resistance                               | R <sub>q</sub>   | f = 1 MHz   |       | 6.1   | 9.2   | Ω     |
| Turn-On Delay Time                            | t <sub>d(on)</sub>   |   |       | 20    | 30    |       |
| Rise Time                                     | t <sub>r</sub>   | $V_{DD} = -75 \text{ V}, R_{1} = 25 \Omega$   |       | 95    | 145   |       |
| Turn-Off DelayTime                            | t <sub>d(off)</sub>  | $I_D \cong -3 \text{ A}, V_{GEN} = -6 \text{ V}, R_g = 1 \Omega$                    |       | 38    | 60    |       |
| Fall Time                                     | t <sub>f</sub>   | 3   |       | 34    | 51    |       |
| Turn-On Delay Time                            | t <sub>d(on)</sub>   |   |       | 11    | 18    | ns    |
| Rise Time                                     | t <sub>r</sub>   | $V_{DD} = -75 \text{ V}, R_{1} = 25 \Omega$   |       | 28    | 42    |       |
| Turn-Off DelayTime                            | t <sub>d(off)</sub>  | $I_D \cong -2 \text{ A}, V_{GEN} = -10 \text{ V}, R_a = 1 \Omega$                   |       | 52    | 78    |       |
| Fall Time                                     | t <sub>f</sub>   | g   |       | 35    | 53    |       |
| Drain-Source Body Diode Characterist          | •  |   |       |       |       |       |
| Continuous Source-Drain Diode Current         | I <sub>S</sub>   | T <sub>C</sub> = 25 °C  |       |       | - 13  | _     |
| Pulse Diode Forward Current <sup>a</sup>      | I <sub>SM</sub>  |   |       |       | - 15  | Α     |
| Body Diode Voltage                            | V <sub>SD</sub>  | I <sub>S</sub> = - 2 A  |       | - 0.8 | - 1.2 | V     |
| Body Diode Reverse Recovery Time              | t <sub>rr</sub>  | <u> </u>  |       | 65    | 90    | ns    |
| Body Diode Reverse Recovery Charge            | Q <sub>rr</sub>  |   |       | 180   | 270   | nC    |
| Reverse Recovery Fall Time                    | t <sub>a</sub>   | $I_F = -4 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 °\text{C}$ |       | 45    |       |       |
| Reverse Recovery Rise Time                    | t <sub>b</sub>   |   |       | 20    |       | ns    |

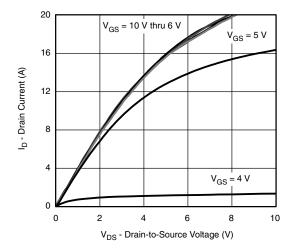
#### Notes:

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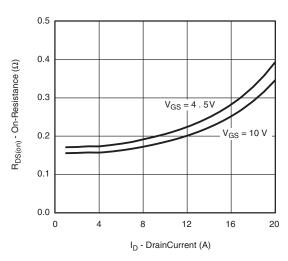
- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

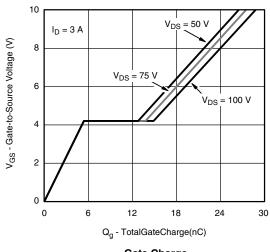




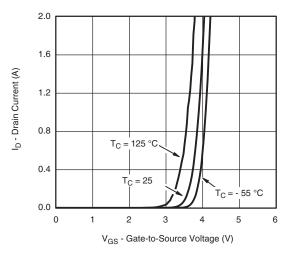
### **Output Characteristics**



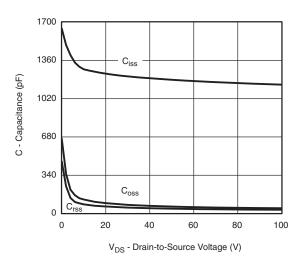
On-Resistance vs. Drain Current and Gate Voltage



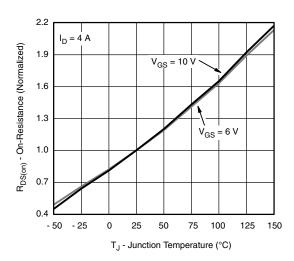
**Gate Charge** 



**Transfer Characteristics** 

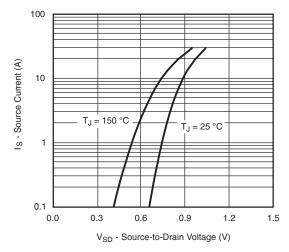


Capacitance

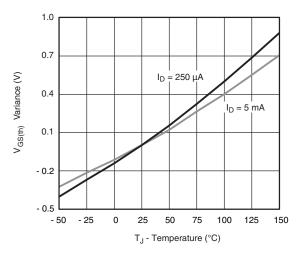


On-Resistance vs. Junction Temperature

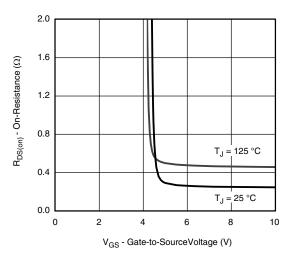




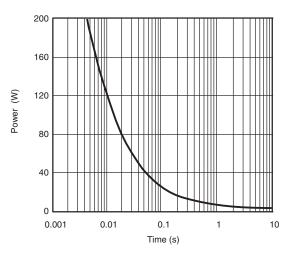
#### Source-Drain Diode Forward Voltage



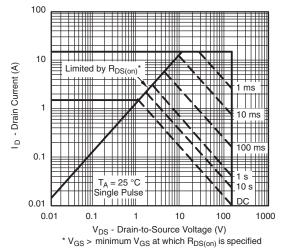
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage

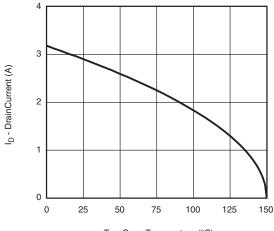


Single Pulse Power, Junction-to-Ambient



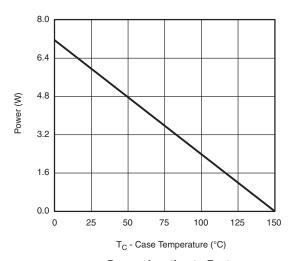
Safe Operating Area, Junction-to-Ambient



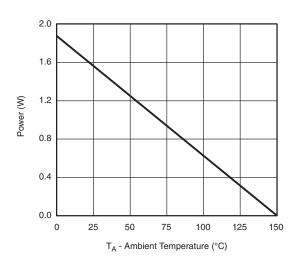


#### T<sub>C</sub> - Case Temperature (°C)

#### **Current Derating\***



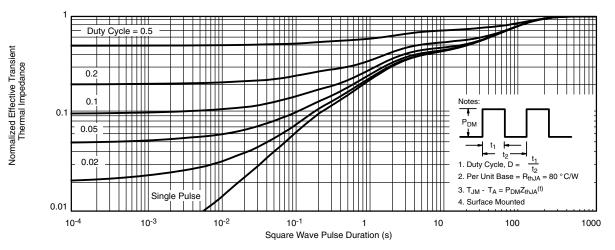




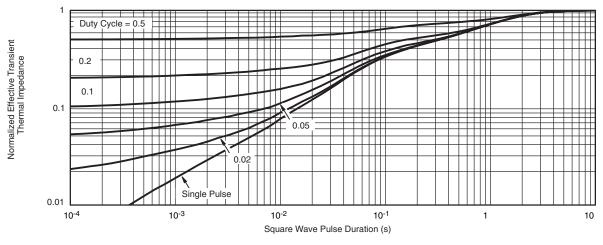
Power, Junction-to-Ambient

<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max.)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





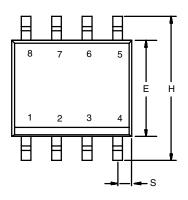
Normalized Thermal Transient Impedance, Junction-to-Ambient

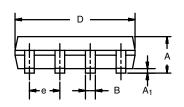


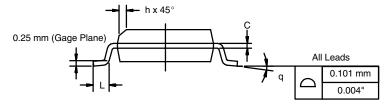
Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







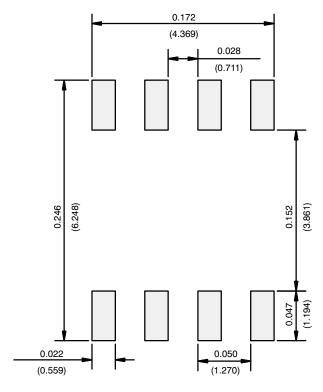
|                                | MILLIM | IETERS | INCHES    |       |  |  |
|--------------------------------|--------|--------|-----------|-------|--|--|
| DIM                            | Min    | Max    | Min       | Max   |  |  |
| Α                              | 1.35   | 1.75   | 0.053     | 0.069 |  |  |
| A <sub>1</sub>                 | 0.10   | 0.20   | 0.004     | 0.008 |  |  |
| В                              | 0.35   | 0.51   | 0.014     | 0.020 |  |  |
| С                              | 0.19   | 0.25   | 0.0075    | 0.010 |  |  |
| D                              | 4.80   | 5.00   | 0.189     | 0.196 |  |  |
| E                              | 3.80   | 4.00   | 0.150     | 0.157 |  |  |
| е                              | 1.27   | BSC    | 0.050 BSC |       |  |  |
| Н                              | 5.80   | 6.20   | 0.228     | 0.244 |  |  |
| h                              | 0.25   | 0.50   | 0.010     | 0.020 |  |  |
| L                              | 0.50   | 0.93   | 0.020     | 0.037 |  |  |
| q                              | 0°     | 8°     | 0°        | 8°    |  |  |
| S                              | 0.44   | 0.64   | 0.018     | 0.026 |  |  |
| ECN: C-06527-Rev. I. 11-Sep-06 |        |        |           |       |  |  |

DWG: 5498

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## **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)



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